Data sheet 6ES7677-2SB42-0GB0



SIMATIC ET 200SP Open Controller, CPU 1515SP PC2 F, 8 GB RAM (basic device 6ES7677-2DB40-0AA0), 128 GB CFast with Windows 10 IoT Enterprise LTSC 2019 64-bit and S7-1500 Failsafe Software Controller CPU 1505SP F V2x preinstalled; interfaces: 1x slot CFast, 1x slot SD/MMC, 1x connection for ET 200SP BusAdapter PROFINET, 1x 10/100/1000 Mbps Ethernet, 2x USB 3.0, 2x USB 2.0, 1x DisplayPort; documentation on CFast, restore image on CFast

General information	
Product type designation	CPU 1515SP PC2 F
HW functional status	from FS04
Firmware version	V20.8
Engineering with	
STEP 7 TIA Portal configurable/integrated from version	V16
Installed software	
Visualization	No
Control	S7-1500 Software Controller CPU 1505SP F
Configuration control	
via dataset	Yes
Control elements	
Mode selector switch	1
Supply voltage	
permissible range, lower limit (DC)	19.2 V
permissible range, upper limit (DC)	28.8 V
Reverse polarity protection	Yes
Mains buffering	
Mains/voltage failure stored energy time	5 ms
Input current	
Current consumption (rated value)	1.8 A; Full processor load, incl. ET 200SP modules and using USB
Current consumption (in no-load operation), typ.	0.5 A
Current consumption, max.	2.9 A
²t	0.426 A ² ·s; with starting current inrush
Power	
Active power input, max.	55 W; incl. ET 200SP modules and using USB
Infeed power to the backplane bus	8.75 W
Power loss	
Power loss, typ.	15 W; without ET 200SP modules and without using USB
Processor	
Processor type	Intel Atom E3940, 1.6 GHz, 4 cores
Memory	
Type of memory	DDR3L
Main memory	8 GB RAM
CFast memory card	Yes; 128 GB flash memory
SIMATIC memory card required	No
Work memory	
integrated (for program)	1.5 Mbyte
integrated (for data)	5 Mbyte
 integrated (for CPU function library of CPU Runtime) 	20 Mbyte

Load moment	
Load memory	320 Mbyte
• integrated (on PC mass storage)	320 Midyte
Backup with UPS	Vacually manner of a control and activities
	Yes; all memory areas declared retentive
with non-volatile memory	Yes
CPU-blocks	
Number of elements (total)	6 000; In addition to blocks such as DBs, FBs and FCs, UDTs, global constants, etc. are also regarded as elements
DB	ochotanto, oto. dio dioc rogando do ciomono
Number, max.	5 999; Number range: 1 to 65535
• Size, max.	5 Mbyte
FB	·
Number, max.	5 998; Number range: 1 to 65535
• Size, max.	1 024 kbyte
FC Size, max.	1 02+ hbyto
Number, max.	5 999; Number range: 1 to 65535
• Size, max.	1 024 kbyte
OB	1 024 kDyte
• Size, max.	1 048 kbyte
Number of free cycle OBs	100
Number of free cycle OBs Number of time alarm OBs	20
Number of time alarm OBs Number of delay alarm OBs	
•	20
Number of cyclic interrupt OBs Number of process plarm OBs	20
Number of process alarm OBs Number of DDV4 clarm OBs	50
Number of DPV1 alarm OBs	3
Number of isochronous mode OBs	1
Number of technology synchronous alarm OBs	2
Number of startup OBs	100
Number of asynchronous error OBs	4
Number of synchronous error OBs	2
Number of diagnostic alarm OBs	1
Nesting depth	
per priority class	24; Up to 8 possible for F-blocks
Counters, timers and their retentivity	
S7 counter	
Number	2 048
Retentivity	
— adjustable	Yes
IEC counter	
Number	Any (only limited by the main memory)
Retentivity	Any (only limited by the main memory)
	Ally (only limited by the main memory)
— adjustable	Yes
— adjustable S7 times	
S7 times	Yes
S7 times ● Number	Yes
S7 times ● Number Retentivity	Yes 2 048
S7 times ● Number Retentivity — adjustable	Yes 2 048
S7 times ● Number Retentivity — adjustable IEC timer	Yes 2 048 Yes
S7 times ● Number Retentivity — adjustable IEC timer ● Number	Yes 2 048 Yes
S7 times • Number Retentivity — adjustable IEC timer • Number Retentivity	Yes 2 048 Yes Any (only limited by the main memory)
S7 times ● Number Retentivity — adjustable IEC timer ● Number Retentivity — adjustable	Yes 2 048 Yes Any (only limited by the main memory)
S7 times • Number Retentivity — adjustable IEC timer • Number Retentivity — adjustable Data areas and their retentivity	Yes 2 048 Yes Any (only limited by the main memory) Yes
● Number Retentivity — adjustable IEC timer ● Number Retentivity — adjustable Data areas and their retentivity Retentive data area (incl. timers, counters, flags), max.	Yes 2 048 Yes Any (only limited by the main memory) Yes
S7 times ● Number Retentivity — adjustable IEC timer ● Number Retentivity — adjustable Data areas and their retentivity Retentive data area (incl. timers, counters, flags), max. Flag	Yes 2 048 Yes Any (only limited by the main memory) Yes 410 kbyte; For storage in NVRAM; for storage in mass storage 5 242 020 bytes
● Number Retentivity — adjustable IEC timer ● Number Retentivity — adjustable Data areas and their retentivity Retentive data area (incl. timers, counters, flags), max. Flag ● Size, max.	Yes 2 048 Yes Any (only limited by the main memory) Yes 410 kbyte; For storage in NVRAM; for storage in mass storage 5 242 020 bytes 16 kbyte
● Number Retentivity — adjustable IEC timer ● Number Retentivity — adjustable Data areas and their retentivity Retentive data area (incl. timers, counters, flags), max. Flag ● Size, max. ● Number of clock memories	Yes 2 048 Yes Any (only limited by the main memory) Yes 410 kbyte; For storage in NVRAM; for storage in mass storage 5 242 020 bytes 16 kbyte
● Number Retentivity — adjustable IEC timer ● Number Retentivity — adjustable Data areas and their retentivity Retentive data area (incl. timers, counters, flags), max. Flag ● Size, max. ● Number of clock memories Data blocks	Yes 2 048 Yes Any (only limited by the main memory) Yes 410 kbyte; For storage in NVRAM; for storage in mass storage 5 242 020 bytes 16 kbyte 8; 8 clock memory bit, grouped into one clock memory byte
S7 times ● Number Retentivity — adjustable IEC timer ● Number Retentivity — adjustable Data areas and their retentivity Retentive data area (incl. timers, counters, flags), max. Flag ● Size, max. ● Number of clock memories Data blocks ● Retentivity adjustable	Yes 2 048 Yes Any (only limited by the main memory) Yes 410 kbyte; For storage in NVRAM; for storage in mass storage 5 242 020 bytes 16 kbyte 8; 8 clock memory bit, grouped into one clock memory byte
S7 times ● Number Retentivity — adjustable IEC timer ● Number Retentivity — adjustable Data areas and their retentivity Retentive data area (incl. timers, counters, flags), max. Flag ● Size, max. ● Number of clock memories Data blocks ● Retentivity adjustable ● Retentivity preset	Yes 2 048 Yes Any (only limited by the main memory) Yes 410 kbyte; For storage in NVRAM; for storage in mass storage 5 242 020 bytes 16 kbyte 8; 8 clock memory bit, grouped into one clock memory byte

N. 1. (10. 11.	0.400
Number of IO modules	8 192
I/O address area	
• Inputs	32 kbyte; All inputs are in the process image
• Outputs	32 kbyte; All outputs are in the process image
of which per assigned PC interface	
— Inputs (volume)	8 kbyte
— Outputs (volume)	8 kbyte
Subprocess images	
Number of subprocess images, max.	32
Hardware configuration	
Integrated power supply	Yes
Number of distributed IO systems	20
Number of DP masters	
• Via CM	1
Rack	
Modules per rack, max.	64; CPU 1515SP PC + 64 modules + server module
 Quantity of operable ET 200SP modules, max. 	64
Quantity of operable ET 200AL modules, max.	16
Number of lines, max.	1
PtP CM	
Number of PtP CMs	the number of connectable PtP CMs is only limited by the number of available
	slots
Time of day	
Clock	
 Type 	Hardware clock
Hardware clock (real-time)	Yes; Resolution: 1 s
Backup time	6 wk; At 40 °C ambient temperature, typically
Deviation per day, max.	10 s; Typ.: 2 s
Clock synchronization	
• supported	Yes
• to DP, master	No
on Ethernet via NTP	Yes
on Windows clock, device	Yes
	160
Interfaces	
Number of industrial Ethernet interfaces	2
Number of PROFINET interfaces	1
Number of PROFIBUS interfaces	1
Number of RS 485 interfaces	1; Via CM DP module
Number of USB interfaces	4; 2x USB 2.0, 2x USB 3.0 on front side
Number of SD card slots	1
Video interfaces	
Graphics interface	1x DisplayPort
1. Interface	
Interface type	PROFINET
automatic detection of transmission rate	Yes
Autonegotiation	Yes
Autocrossing	Yes
Number of connections	88
Interface types	
RJ 45 (Ethernet)	Yes; Via BusAdapter BA 2x RJ45
— Transmission rate, max.	100 Mbit/s
Industrial Ethernet status LED	Yes
Number of ports	2
• integrated switch	Yes
BusAdapter (PROFINET)	Yes; Compatible BusAdapter: BA 2x RJ45, BA 2x FC, BA 2x SCRJ (from FS03,
Dushuapici (i NOFINET)	V2.2), BA SCRJ / RJ45 (from FS03, V3.1), BA SCRJ / FC (from FS03, V3.1), BA 2x LC (from FS03, V3.3), BA LC / RJ45 (from FS03, V3.3), BA LC / RJ45 (from FS03, V3.3), BA LC / FC (from FS03, V3.3)
Protocols	
PROFINET IO Controller	Yes
PROFINET IO Device	Yes
 SIMATIC communication 	Yes

Open IE communication	Yes
Web server	Yes
PROFINET IO Controller	
Services	
— Isochronous mode	Yes
— shortest clock pulse	500 μs
— IRT	Yes
 Prioritized startup 	Yes; Max. 32 PROFINET devices
 Number of connectable IO Devices, max. 	128
— Of which IO devices with IRT, max.	64
— of which in line, max.	64
Number of connectable IO Devices for RT, max.	128
— of which in line, max.	128
 Number of IO Devices that can be simultaneously activated/deactivated, max. 	8
 — IO Devices changing during operation (partner ports), supported 	Yes
Number of IO Devices per tool, max.	8
— Updating times	The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data
Update time for IRT	
— for send cycle of 500 μs	500 µs to 8 ms
— for send cycle of 1 ms	1 ms to 16 ms
— for send cycle of 2 ms	2 ms to 32 ms
— for send cycle of 4 ms	4 ms to 64 ms
With IRT and parameterization of "odd" send cycles	Update time = set "odd" send clock (any multiple of 125 μs : 625 μs 3 875 $\mu s)$ minimum cycle time start from 500 μs
Update time for RT	
— for send cycle of 500 μs	500 μs to 256 ms
— for send cycle of 1 ms	1 ms to 512 ms
— for send cycle of 2 ms	2 ms to 512 ms
— for send cycle of 4 ms	4 ms to 512 ms
PROFINET IO Device	
Services	
 Isochronous mode 	No
— IRT	Yes
 Prioritized startup 	Yes
— Shared device	Yes
 Number of IO Controllers with shared device, max. 	4
2. Interface	
Interface type	Integrated Ethernet interface
automatic detection of transmission rate	Yes
Autonegotiation	Yes
Autocrossing	Yes
Interface types	
RJ 45 (Ethernet)	Yes; Integrated
— Transmission rate, max.	1 000 Mbit/s
Industrial Ethernet status LED	No
Number of ports	1
3. Interface	
Interface type	PROFIBUS with CM DP
Number of connections	44
Interface types	
• RS 485	Yes
Protocols	, 00
PROFIBUS DP master	
	Voc
	Yes
PROFIBUS DP device	Yes
PROFIBUS DP device SIMATIC communication	
PROFIBUS DP deviceSIMATIC communicationPROFIBUS DP master	Yes Yes
PROFIBUS DP device SIMATIC communication	Yes

— Equidistance	No No
— Isochronous mode	No
Interface types RS 485	
Transmission rate, max.	12 Mbit/s
Protocols	12 Hibito
PROFIsafe	Yes; V2.4 / V2.6
Number of connections	100, 12.17 12.0
Number of connections, max.	88
Number of connections reserved for ES/HMI/web	10
 Number of S7 routing paths 	16
Redundancy mode	
Media redundancy	
— MRP	Yes
— MRPD	Yes
 Switchover time on line break, typ. 	200 ms
 Number of stations in the ring, max. 	50
SIMATIC communication	
 PG/OP communication 	Yes
S7 routing	Yes
S7 communication, as server	Yes
• S7 communication, as client	Yes
User data per job, max.	64 kbyte
Open IE communication	
• TCP/IP	Yes
— Data length, max.	64 kbyte
• ISO-on-TCP (RFC1006)	Yes
— Data length, max.	64 kbyte
• UDP	Yes
— Data length, max.	2 048 byte
• SNMP	Yes
• DCP	Yes
• LLDP	Yes
Web server ◆ HTTP	Yes; Via Windows and PROFINET interface
• HTTPS	Yes; Via Windows and PROFINET interface Yes; Via Windows and PROFINET interface
OPC UA	res, via vvindows and rivor inclinenace
Runtime license required	Yes; "Small" license required
OPC UA Client	Yes; Data access (read, write), method call
Application authentication	Yes
— Security policies	Yes; Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
 User authentication 	Yes; "anonymous" or by user name & password
 Number of connections, max. 	10
 Number of nodes of the client interfaces, recommended max. 	2 000
 Number of elements for one call of OPC_UA_NodeGetHandleList/OPC_UA_ReadList/OPC_I max. 	300
 Number of elements for one call of OPC_UA_NameSpaceGetIndexList, max. 	20
 Number of elements for one call of OPC_UA_MethodGetHandleList, max. 	100
 Number of simultaneous calls of the client instructions for session management, per connection, max. 	1
 Number of simultaneous calls of the client instructions for data access, per connection, max. 	5
 Number of registerable nodes, max. 	2 000
 Number of registerable method calls of OPC_UA_MethodCall, max. 	100
 Number of inputs/outputs when calling OPC_UA_MethodCall, max. 	20
OPC UA Server	Yes; Data access (read, write, subscribe), runtime license required

 Application authentication 	Yes; Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256	
— Security policies	Yes; Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256	
 User authentication 	Yes; "anonymous" or by user name & password	
 Number of sessions, max. 	48	
 Number of accessible variables, max. 	100 000	
 Number of registerable nodes, max. 	20 000	
Number of subscriptions per session, max.	20	
— Sampling interval, min.	100 ms	
— Publishing interval, min.	200 ms	
Number of server methods, max.	50	
Number of inputs/outputs per server method, max.	20	
Number of monitored items, recommended max.	2 000; for 1 s sampling interval and 1 s send interval	
Number of server interfaces, max.	10	
Number of nodes for user-defined server interfaces,	5 000	
max.		
Further protocols		
• MODBUS	Yes; MODBUS TCP	
S7 message functions		
Number of login stations for message functions, max.	32	
Program alarms	Yes	
Number of configurable program messages, max.	10 000	
Number of simultaneously active program alarms		
Number of program alarms	1 000	
Number of alarms for system diagnostics	200	
Number of alarms for motion technology objects	160	
Test commissioning functions		
Joint commission (Team Engineering)	Yes; Parallel online access possible for up to 8 engineering systems	
Status block	Yes; up to 8 simultaneously	
	No	
Single step	NO	
Status/control	Von	
Status/control variable	Yes	
Variables Number of variables, many	Inputs, outputs, memory bits, DB, times, counters	
Number of variables, max.	000	
— of which status variables, max.	200	
— of which control variables, max.	200	
Forcing		
• Forcing	Yes	
• Forcing, variables	Inputs, outputs	
Number of variables, max.	200	
Diagnostic buffer		
• present	Yes	
Number of entries, max.	1 000	
— of which powerfail-proof	300	
Traces		
 Number of configurable Traces 	4	
Memory size per trace, max.	512 kbyte	
Interrupts/diagnostics/status information		
Diagnostics indication LED		
RUN/STOP LED	Yes	
• ERROR LED	Yes	
MAINT LED	Yes	
Supported technology objects		
Motion Control	Yes	
 Number of available Motion Control resources for 	2 400	
technology objects		
 Required Motion Control resources 		
per speed-controlled axis	40; per axis	
— per positioning axis	80; per axis	
— per synchronous axis	160; per axis	
— per external encoder	80; per external encoder	

— per output cam	20: per cam
	20; per cam
— per cam track	160; per cam track
— per probe	40; per probe
Positioning axis Number of positioning axes at motion control cycle of 4 mg (hyrical value).	15
of 4 ms (typical value) — Number of positioning axes at motion control cycle	30
of 8 ms (typical value) Controller	
PID_Compact	Yes; Universal PID controller with integrated optimization
• PID_3Step	Yes; PID controller with integrated optimization for valves
• PID-Temp	Yes; PID controller with integrated optimization for temperature
Counting and measuring	res, FID controller with integrated optimization for temperature
High-speed counter	Yes
Standards, approvals, certificates	
CE mark	Yes
CSA approval	Yes
cULus	Yes
FM approval	Yes
RCM (formerly C-TICK)	Yes
Highest safety class achievable in safety mode	160
Performance level according to ISO 13849-1	PLe
SIL acc. to IEC 61508	SIL 3
Probability of failure (for service life of 20 years and repair time	
Low demand mode: PFDavg in accordance with SIL3	< 2.00E-05
High demand/continuous mode: PFH in accordance with SIL3	< 1.00E-09 1/h
Ambient conditions	
Ambient temperature during operation	
• min.	-20 °C
• max.	Up to 60 °C with max. 32 ET 200SP modules and 3x 100 mA USB load; up to
	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load
 horizontal installation, min. 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100
	$55^{\circ}\mathrm{C}$ with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load
horizontal installation, min.	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C
horizontal installation, min.horizontal installation, max.vertical installation, min.	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C
horizontal installation, min.horizontal installation, max.	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes
horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-7 tested according to IEC 60068-2-7	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes
horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-7 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes
horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-7 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes
horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-7 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system configuration / header	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-7 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system configuration / header configuration / programming / header 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-7 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system configuration / header configuration / programming / header Programming language 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system configuration / header configuration / programming / header Programming language LAD 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system configuration / header configuration / programming / header Programming language LAD FBD 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system configuration / header configuration / programming / header Programming language LAD FBD STL 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-7 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system configuration / header configuration / programming / header Programming language LAD FBD STL SCL 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-7 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system configuration / header configuration / programming / header Programming language LAD FBD STL SCL CFC 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
 horizontal installation, min. horizontal installation, max. vertical installation, min. vertical installation, max. Ambient temperature during storage/transportation min. max. Vibrations Operation, tested according to IEC 60068-2-6 Transport, tested acc. to IEC 60068-2-6 Shock testing tested according to IEC 60068-2-6 tested according to IEC 60068-2-27 tested according to IEC 60068-2-29 Storage/transport, tested acc. to IEC 60068-2-27 Operating systems pre-installed operating system configuration / header configuration / programming / header Programming language LAD FBD STL SCL CFC GRAPH 	55 °C with max. 64 ET 200SP modules and 2x max. 500 mA and 1x max. 100 mA USB load -20 °C 60 °C -20 °C 50 °C; With max. 32 ET 200SP modules and 3x 100 mA USB load -40 °C 70 °C Yes Yes Yes Yes Yes Yes Yes Yes Yes Ye
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Copy protection	Yes			
Block protection	Yes	Yes		
Access protection				
 Protection level: Write protection 	Yes			
 Protection level: Read/write protection 	Yes			
 Protection level: Complete protection 	Yes	Yes		
programming / cycle time monitoring / header				
 lower limit 	adjustable minimum cycle tin	adjustable minimum cycle time		
upper limit	adjustable maximum cycle tir	adjustable maximum cycle time		
Open Development interfaces				
 Size of ODK SO file, max. 	3.8 Mbyte			
Peripherals/Options				
SD card	Optionally for additional mass	s storage		
Dimensions				
Width	160 mm			
Height	117 mm	117 mm		
Depth	75 mm	75 mm		
Weights				
Weight, approx.	0.83 kg			
Classifications				
		Version	Classification	
	eClass	14	27-24-26-07	
	- 01	40	07.04.00.07	

	Version	Classification
eClass	14	27-24-26-07
eClass	12	27-24-26-07
eClass	9.1	27-24-26-07
eClass	9	27-24-26-07
eClass	8	27-24-26-07
eClass	7.1	27-24-26-07
eClass	6	27-24-26-07
ETIM	9	EC001603
ETIM	8	EC001603
ETIM	7	EC001603
IDEA	4	3565
UNSPSC	15	32-15-17-05

Approvals / Certificates

General Product Approval Marine / Shipping Environment

Manufacturer Declaration

Miscellaneous







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